

IN THE CLAIMS:

Please cancel Claim 6 without prejudice or disclaimer of the subject matter presented therein and without conceding the correctness of its rejection. Please amend Claim 5 as shown below. The claims, as pending in the subject application, read as follows:

B1
1 to 4. (Cancelled)

5. (Currently Amended) An image pickup apparatus comprising:
a lead of a flexible wiring film;
an image pickup element chip electrically connected to the lead at an electrical connection point; and
a cover glass for protecting a surface of the image pickup element chip,
wherein the lead, the image pickup element chip, and the cover glass are sealed with a sealant ~~an ultraviolet-curing resin~~ in a peripheral portion of the image pickup element chip, and
wherein the lead has a hole formed in a portion of the lead in contact with the sealant ~~ultraviolet-curing resin~~, the portion of the lead being between the electrical connection point and an outer end of the lead, and
wherein a part of the hole is positioned outside the cover glass.

6 and 7. (Cancelled)

b7

8. (Previously Presented) The image pickup apparatus according to Claim 5,
wherein at least one of a layer for preventing reflection of external light and a layer for
preventing multiple reflection is formed between the lead and the cover glass.

9. (Previously Presented) An image pickup system comprising:
the image pickup apparatus according to Claim 5;
an optical system for focusing light on the image pickup apparatus; and
a signal processing circuit for processing an output signal from the image
pickup apparatus.

10 and 11. (Cancelled)
